


	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE		COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE
△						△					
△						△					
APPLICABLE STANDARD											
RATING	Operating Temperature Range		-55°C to +105°C (Note1)			Storage Temperature Range		-10°C to +60°C (Note3)			
	Operating Humidity Range		20% to 80% (Note2)			Storage Humidity Range		40% to 70% (Note3)			
	Applicable Connector		DF51K-*(D)S-2C (###)			Voltage		250V AC/DC			
	Applicable Cable		AWG#24 to 28			Current	AWG 28 : 1A AWG 26 : 1.5A AWG 24 : 2A				
	Insulation Diameter		φ 0.9 ~ φ 1.45 mm								
SPECIFICATIONS											
ITEM		TEST METHOD				REQUIREMENTS			QT	AT	
CONSTRUCTION											
General Examination		Visually and by measuring instrument.				According to drawing.			o	o	
Marking		Confirmed visually.							o	o	
ELECTRICAL CHARACTERISTICS											
Contact Resistance		20mV MAX, 1mA (DC or 1000Hz).				30 mΩ MAX.			o	-	
Millivolt Level Method											
MECHANICAL CHARACTERISTICS											
Mechanical Operation (Sn Plating)		30 times insertion and extraction.				①Contact resistance: 30mΩ MAX ②No damage, crack or looseness of parts.			o	-	
Mechanical Operation (Au Plating)		50 times insertion and extraction.				①Contact resistance: 30mΩ MAX ②No damage, crack or looseness of parts.			o	-	
Vibration		Frequency 10 to 55 Hz, single amplitude 0.75 mm, at 10 cycles for 3 direction.				①No electrical discontinuity of 1 μ s. ②No damage, crack or looseness of parts.			o	-	
Shock		Acceleration 490 m/s ² duration of pulse 11 ms at 3 times for 3 directions.							o	-	
ENVIRONMENTAL CHARACTERISTICS											
Damp Heat (Steady State)		Exposed at 40 ± 2 °C , humidity 90 to 95 %, 96 h. (After leaving the room temperature for 1 to 2h.)				①Contact resistance: 30 mΩ MAX. ②No damage, crack or looseness of parts.			o	-	
Rapid Change of Temperature		Temperature -55 °C→ +105 °C Time 30min→ 30min Under 5 Cycles. (The transferring time of the tank is 2 to 3 MIN) (After leaving the room temperature for 1 to 2h.)				①Contact resistance: 30 mΩ MAX. ②No damage, crack or looseness of parts.			o	-	
Remarks Note 1: Include the temperature rising by current. Note 2: No condensing Note 3: Apply to the condition of long term storage for unused products before pcb on board, after pcb board , operating temperature and humidity range is applied for interim storage during transportation.											
					DRAWN J.S CHOI 17.12.22	DESIGNED J.S CHOI 17.12.22	CHECKED S.M.LIM 17.12.22	APPROVED T.S KANG 17.12.22	RELEASED 		
Unless otherwise specified, refer to IEC 60512.											
NOTE QT: QUALIFICATION TEST AT: ASSURANCE TEST O: APPLICABLE TEST											
HIROSE KOREA CO.,LTD.			SPECIFICATION SHEET				PART NO. DF51K-2428SCFA (800)				
CODE NO.(OLD) CL		DRAWING NO. ELC4-611495			CODE NO. CL 6652-0042-9-800				1 1		